

TRM500 v1.0



Copyright © 2025, UAB TELTONIKA NETWORKS. Specifications and information given in this document are subject to change by UAB TELTONIKA NETWORKS without prior notice.



HARDWARE

FRONT VIEW



BACK VIEW



POWER SOCKET PINOUT





FEATURES

Mobile		
Mobile module	5G Sub-6GHz SA: 2.4Gbps (DL)/900Mbps (UL); 5G NSA Sub-6GHz: 3.4Gbps DL (4x4 MIMO)/ 550 Mbps UL (2x2); 4G (LTE-FDD) – LTE Cat 19 1.6Gbps DL, 200Mbps UL; 3G – 42 Mbps DL, 5.76Mbps UL	
3GPP Release	Release 16	
Power		
Connector	1 x 4-pin industrial DC power socket 1 x USB Type-C (The USB host must provide 5V @ 3A to power the device via the USB Type-C port)	
Input voltage range	4-pin: 9 - 30 VDC, overvoltage protection, reverse polarity protection, surge protection >35 VDC 10us max USB Type-C: 5 VDC	
Power consumption	ldle: < 5 W, Max: < 12 W	
Physical Interfaces		
Status LEDs	1 x Power LED, 1 x 5G LED, 1 x Network LED	
SIM	1 x SIM slot (Mini SIM – 2FF), 1.8 V/3 V	
Power	1 x 4-pin power connector 1 x USB Type-C (The USB host must provide 5V @ 3A to power the device via the USB Type-C port)	
Antennas	4 x SMA for Mobile	
Other	1 x Virtual network interface via USB Type-C (For power and network data)	
Physical Specification		
Casing material	Anodized aluminum housing and panels	
Dimensions (W x H x D)	83 x 25 x 85.4 mm	
Weight	94.5 g	
Mounting options	DIN rail, wall mount, flat surface (all require additional kit)	
Operating Environment		
Operating temperature	-40 °C to 75 °C	
Operating humidity	10% to 90% non-condensing	
Ingress Protection Rating	IP30	



DATASHEET - TRM500

TRM SOFTWARE

Management Software	Windows Connection Manager, Modem Manager (Linux)
USB Serial Driver	Windows 7/8/8.1/10/11,Linux 2.6~6.3,Android 4.x ~ 13
GNSS Driver	Android 4.x ~ 13
RIL Driver	Android 4.x ~ 13
NDIS Driver	Windows 7/8/8.1/10/11
MBIM Driver	Windows 8/8.1/10/11, Linux 3.18~6.3
Gobinet Driver	Linux 2.6/3.x/4.1~4.14
QMI_WWAN Driver	Linux 3.4~6.3
Regulatory & Type Approvals	
Regulatory	CE, UKCA, RCM, CB, WEEE
EMC Emissions & Immunity	
Standards	EN 55032:2015+A1:2020
	EN 55035:2017+A11:2020
	EN 61000-3-3:2013+A1:2019+A2:2021
	EN IEC 61000-3-2:2019+A1:2021
	EN 301 489-1 V2.2.3
	EN 301 489-52 V1.2.1
	AS/NZS CISPR 32:2015+A1:2020
ESD	EN 61000-4-2: 2009
Radiated Immunity	EN IEC 61000-4-3: 2020
EFT	EN 61000-4-4: 2012
Surge Immunity (AC Mains Power Port)	EN 61000-4-5: 2014+A1: 2017
CS	EN 61000-4-6: 2014
DIP	EN IEC 61000-4-11:2020



RF

Standards

EN 301 908-1 V15.2.1
EN 301 908-2 V13.1.1
EN 301 908-13 V13.2.1
EN 301 908-25 V15.1.1
AS/CA S042.1:2022
AS/CA S042.4:2022
AS/CA S042.5:2022+A1:2022
FCC Part 22
Draft EN 301 908-25 V15.1.1_0.0.21

Safety

Standards

CE: EN IEC 62368-1:2020+A11:2020, EN IEC 62311:2020 RCM: AS/NZS CISPR 32: 2015+A1:2020 CB: EN IEC 62368-1:2020+A11:2020



ORDERING

STANDARD PACKAGE*



QSG (QUICK START GUIDE)

- TRM500
- 9 W PSU
- 4x 5G Mobile antenna (swivel, SMA male)
- 1x hex key
- SIM Adapter kit
- QSG (Quick Start Guide)
- USB Type-C cable (0.8 m)
- Packaging box

*Standard package contents may differ based on standard order codes.

For more information on all available packaging options - please contact us directly.



CLASSIFICATION CODES

HS Code: 851762 HTS: 8517.62.00

AVAILABLE VERSIONS

TRM500 0 *****	5G NR(SA/NSA): n1, n3, n5, n7, n8, n20, n28,	TRM500000000 / Standard
EMEA ¹ , APAC ² , Brazil	n38, n40, n41, n71, n75, n76, n77, n78	package with EU PSU
	4G (LTE-FDD): B1, B3, B5, B7, B8, B20, B28, B32,	TRM500000200 / Standard
	B71	package with UK PSU
	4G (LTE-TDD): B38, B40, B41, B42, B43	TRM500000300 / Standard
	3G: B1, B5, B8	package with AU PSU

1 - Regional availability - excluding Russia, Belarus & Iran

2 - Excluding China/Japan

The price and lead-times for region (operator) specific versions may vary. For more information please contact us.

TRM500 SPATIAL MEASUREMENTS

PHYSICAL SPECIFICATION

Device housing*:	83 x 25 x 85.4 mm	
Box:	355 x 60 x 175 mm	
	*Housing measurements are presented without antenna connectors and screws; for	

measurements of other device elements look to the sections below.



TOP VIEW

The figure below depicts the measurements of device and its components as seen from the top:



REAR VIEW

The figure below depicts the measurements of device and its components as seen from the back panel side:





FRONT VIEW

The figure below depicts the measurements of device and its components as seen from the front panel side:



MOUNTING SPACE REQUIREMENTS

The figure below depicts an approximation of the device's dimensions when cables and antennas are attached:





DIN RAIL

The scheme below depicts protrusion measurements of an attached DIN Rail:

